

RoHS COMPLIANT

HALOGEN FREE

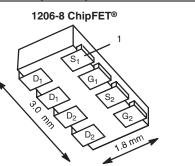
Available

**Vishay Siliconix** 

P-Channel MOSFET

## N- and P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY							
	$V_{DS}(V)$	<b>R<sub>DS(on)</sub> (</b> Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
N-Channel	20	0.052 at V <sub>GS</sub> = 4.5 V	6.1 <sup>a</sup>	3.9 nC			
		0.084 at V <sub>GS</sub> = 2.5 V	4.8 <sup>a</sup>	3.9110			
P-Channel	- 20	0.090 at V <sub>GS</sub> = - 4.5 V	- 4.8 <sup>a</sup>	3.8 nC			
		0.160 at $V_{GS}$ = - 2.5 V	- 3.6 <sup>a</sup>	3.0 110			

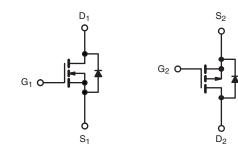


#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFETs
- Compliant to RoHS Directive 2002/95/EC

#### **APPLICATIONS**

Complementary MOSFET for Portable Devices - Ideal for Buck-Boost Circuits



N-Channel MOSFET

Bottom View Ordering Information: Si5509DC-T1-E3 (Lead (Pb)-free) Si5509DC-T1-GE3 (Lead (Pb)-free and Halogen-free)

<b>ABSOLUTE MAXIMUM RATINGS</b>	T <sub>A</sub> = 25 °C, unles	ss otherwise	noted		
Parameter		Symbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V <sub>DS</sub>	20	- 20	V	
Gate-Source Voltage	V <sub>GS</sub>	± 12		v	
	T <sub>C</sub> = 25 °C		6.1 <sup>a</sup>	- 4.8 <sup>a</sup>	
Continuous Drain Current ( $T_{1} = 150 \ ^{\circ}C$ )	T <sub>C</sub> = 70 °C	I <sub>D</sub>	4.9 <sup>a</sup>	- 3.8 <sup>a</sup>	
	T <sub>A</sub> = 25 °C		5.0 <sup>b, c</sup>	- 3.9 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		3.9 <sup>b, c</sup>	- 3.1 <sup>b, c</sup>	А
Pulsed Drain Current		I <sub>DM</sub>	10	- 15	
Source Drain Current Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	3.7	- 3.7	
Source Drain Current Diode Current	T <sub>A</sub> = 25 °C	'S	1.7 <sup>b, c</sup>	1.7 <sup>b, c</sup> - 1.7 <sup>b, c</sup>	
	T <sub>C</sub> = 25 °C		4.5	4.5	
Movimum Dower Dissinction	T <sub>C</sub> = 70 °C	- P <sub>D</sub>	2.88	2.88	W
Maximum Power Dissipation	T <sub>A</sub> = 25 °C		2.1 <sup>b, c</sup>	2.1 <sup>b, c</sup>	vv
	T <sub>A</sub> = 70 °C		1.33 <sup>b, c</sup>	1.33 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150		°C
Soldering Recommendations (Peak Temperature) <sup>d, e</sup>			260		-0

Lot Traceability and Date Code

#### THERMAL RESISTANCE RATINGS

			N-Channel P-Channel					
Parameter	Symbol	Тур.	Max.	Тур.	Max.	Unit		
Maximum Junction-to-Ambient <sup>b, f</sup>	t ≤ 5 s	R <sub>thJA</sub>	50	60	50	60	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	30	40	30	40	0/11	

Notes:

a. Based on  $T_C = 25$  °C. b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

d. See Reliability Manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequade bottom side solder interconnection.

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

Marking Code

ED XXX

Part # Code

f. Maximum under steady state conditions is 90 °C/W for both channels.

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Parameter	Symbol	Test Conditions		Min.	Typ. <sup>a</sup>	Max.	Unit
Static						1	
Drain-Source Breakdown Voltage	N	$V_{GS} = 0 V$ , $I_{D} = 250 \mu A$	N-Ch	20			
	V <sub>DS</sub>	$V_{GS} = 0 V$ , $I_{D} = -250 \mu A$	P-Ch	- 20			V
	<u>м</u> (т	I <sub>D</sub> = 250 μA	N-Ch		18.4		
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA	P-Ch		- 15.1		
	A)( /T	I <sub>D</sub> = 250 μA	N-Ch		- 3.4		mV/°
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA	P-Ch		2.2		
Oata Thuashald Maltana	V	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	N-Ch	0.7		2	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	P-Ch	- 0.7		- 2	V
Gate-Body Leakage		$V_{DS} = 0 V, V_{GS} = \pm 12 V$	N-Ch			100	n۸
Gale-Douy Leakage	I <sub>GSS</sub>		P-Ch			- 100	nA
		$V_{DS} = 20 V, V_{GS} = 0 V$	N-Ch			1	
Zero Gate Voltage Drain Current	Inco	$V_{DS} = -20 V, V_{GS} = 0 V$	P-Ch			- 1	μA
Zero Gale voltage Drain Current	IDSS	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C	N-Ch			10	
		$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 55 °C	P-Ch			- 10	
On-State Drain Current <sup>b</sup>		$V_{DS} \le 5$ V, $V_{GS}$ = 4.5 V	N-Ch	10			A
	I <sub>D(on)</sub>	$V_{DS} \le$ - 5 V, $V_{GS}$ = - 4.5 V	P-Ch	- 15			
Drain-Source On-State Resistance <sup>b</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.0 \text{ A}$	N-Ch		0.043	0.052	
		V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 3.9 A	P-Ch		0.074	0.090	Ω
		V <sub>GS</sub> = 2.5 V, I <sub>D</sub> = 3.9 A	N-Ch		0.068	0.084	
		V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 2.9 A	P-Ch		0.128	0.160	
		V <sub>DS</sub> = 10 V, I <sub>D</sub> = 5.0 A	N-Ch		10.4		
Forward Transconductance <sup>b</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 3.9 A	P-Ch		8.2		S
Dynamic <sup>a</sup>			1				
-	6		N-Ch		455		
Input Capacitance	C <sub>iss</sub>	N-Channel	P-Ch		300		
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 10 V$ , $V_{GS} = 0 V$ , f = 1 MHz	N-Ch		85		pF
	Coss	P-Channel	P-Ch		95		
Reverse Transfer Capacitance	C <sub>rss</sub>	$V_{DS}$ = - 10 V, $V_{GS}$ = 0 V, f = 1 MHz	N-Ch		50		
· · · · · · · · · · · · · · · · · · ·	133		P-Ch		65		
Total Gate Charge	Qg	$V_{DS} = 10 \text{ V}, V_{GS} = 5 \text{ V}, I_D = 4.0 \text{ A}$	N-Ch		4.4	6.6	-
		$V_{DS}$ = - 10 V, $V_{GS}$ = - 5 V, $I_D$ = - 3.9 A	P-Ch		4.1	6.2	4
-	9	N-Channel	N-Ch		3.8	5.7	-
		$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 4.0 \text{ A}$	P-Ch		3.9	5.9	nC
Gate-Source Charge	Q <sub>gs</sub>		N-Ch		0.9		
-	Q <sub>gd</sub>	P-Channel	P-Ch		0.7		-
Gate-Drain Charge		$V_{DS}$ = - 10 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 3.9 A	N-Ch		0.95		-
		+	P-Ch N-Ch		1.25		
Gate Resistance	R <sub>g</sub>	f = 1 MHz			1.9		Ω



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Parameter	Symbol	Test Conditions			Typ. <sup>a</sup>	Max.	Unit
Dynamic <sup>a</sup>							
Turn-On Delay Time	<b>t</b>		N-Ch		6	9	
Turn-On Delay Time	t <sub>d(on)</sub>	N-Channel $V_{DD}$ = 10 V, R <sub>L</sub> = 2.5 $\Omega$ I <sub>D</sub> $\cong$ 4.0 A, V <sub>GEN</sub> = 4.5 V, R <sub>g</sub> = 1 $\Omega$	P-Ch		8	12	- ns
Rise Time	t <sub>r</sub>		N-Ch		95	143	
		$D = 4.0 \text{ A}, V_{\text{GEN}} = 4.0 \text{ V}, H_{\text{g}} = 1.22$	P-Ch		75	113	
Turn-Off Delay Time	t <sub>d(off)</sub>	P-Channel	N-Ch		12	18	
	<b>'</b> a(on)	$V_{DD}$ = - 10 V, $R_L$ = 3.2 $\Omega$	P-Ch		25	38	
Fall Time	t <sub>f</sub>	$I_D \cong$ - 3.14 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$	N-Ch		6	9	
	4		P-Ch		60	90	
Drain-Source Body Diode Characteristic	s		-				
Continuous Source-Drain Diode Current	ا <sub>S</sub>	T <sub>C</sub> = 25 °C	N-Ch			3.75	
Continuous Cource Drain Diode Ourient	-5		P-Ch			- 3.75	А
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>		N-Ch			10	А
Fulse Diode Forward Current	Current~ 'SM		P-Ch			- 15	
Dady Diada Valtaga	V <sub>SD</sub>	$I_{S} = 2.4 \text{ A}, V_{GS} = 0 \text{ V}$	N-Ch		0.8	1.2	v
Body Diode Voltage		I <sub>S</sub> = - 1.5 A, V <sub>GS</sub> = 0 V	P-Ch		- 0.8	- 1.2	
Body Diode Reverse Recovery Time	t <sub>rr</sub>		N-Ch		12	18	
			P-Ch		18	27	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	N-Channel I <sub>F</sub> = 2.4 A, dl/dt = 100 A/µs, T <sub>J</sub> = 25 °C	N-Ch		5	8	nC
			P-Ch		8	12	no
Reverse Recovery Fall Time	t <sub>a</sub>	P-Channel	N-Ch		7.5		
		$I_F = -1.5 \text{ A}, \text{ dI/dt} = -100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$	P-Ch		14		ns
Reverse Recovery Rise Time	t <sub>b</sub>		N-Ch		4.5		115
			P-Ch		4		

Notes:

a. Guaranteed by design, not subject to production testing.

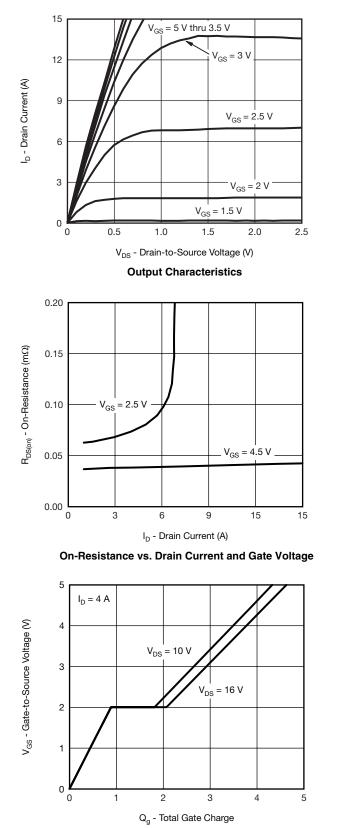
b. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

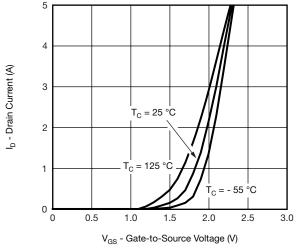


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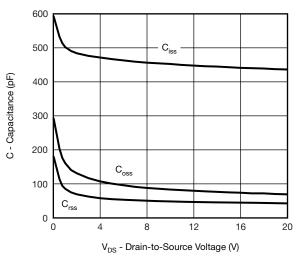
### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



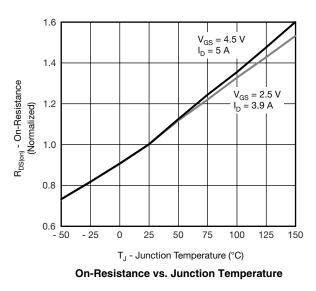
**Gate Charge** 



**Transfer Characteristics** 





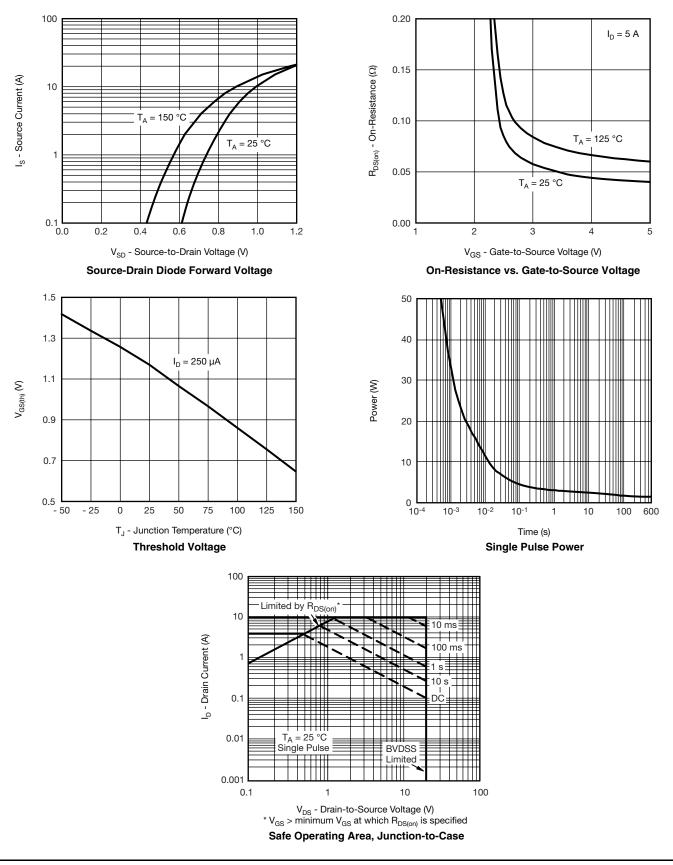


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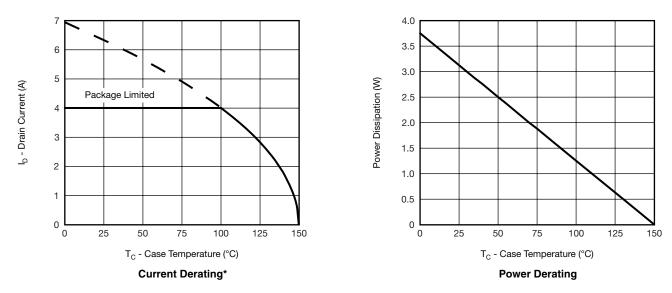
### Si5509DC Vishay Siliconix

#### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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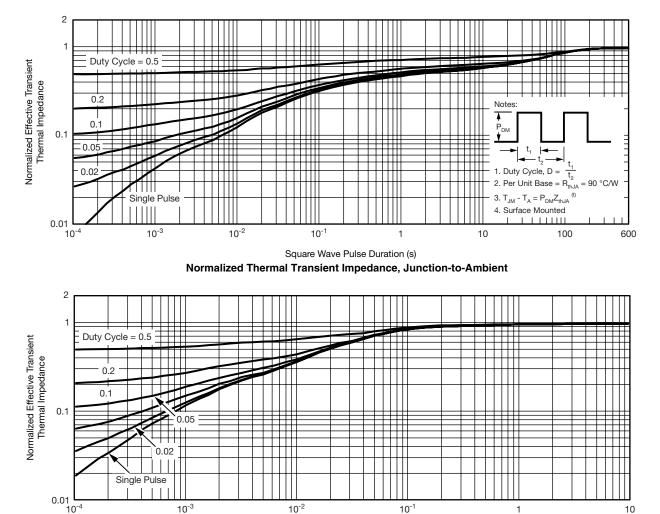


### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



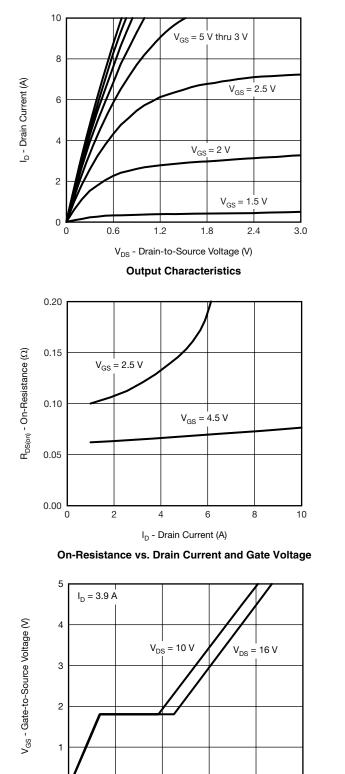
#### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Foot







2

Q<sub>a</sub> - Total Gate Charge

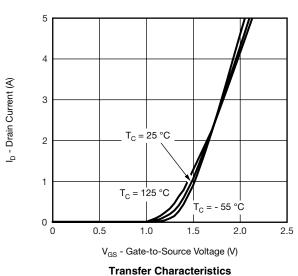
**Gate Charge** 

1

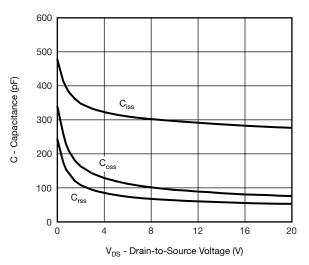
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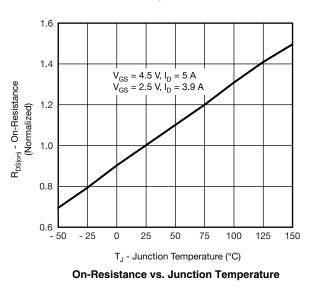
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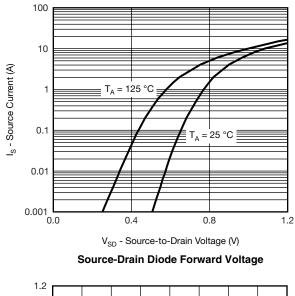
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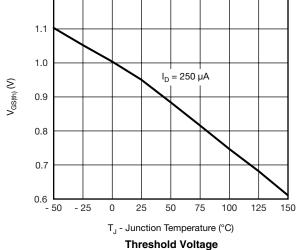
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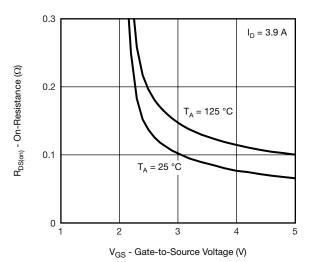
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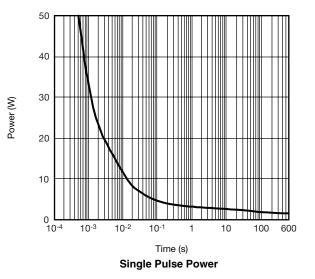
#### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

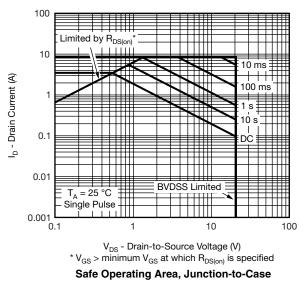






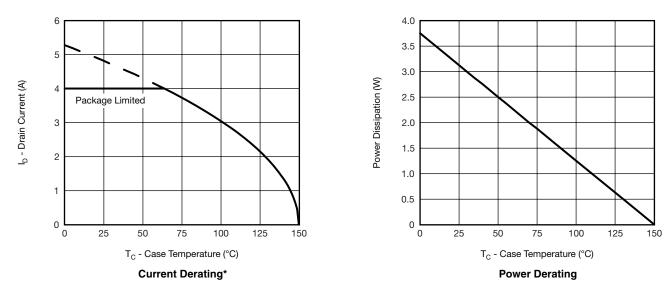
On-Resistance vs. Gate-to-Source Voltage







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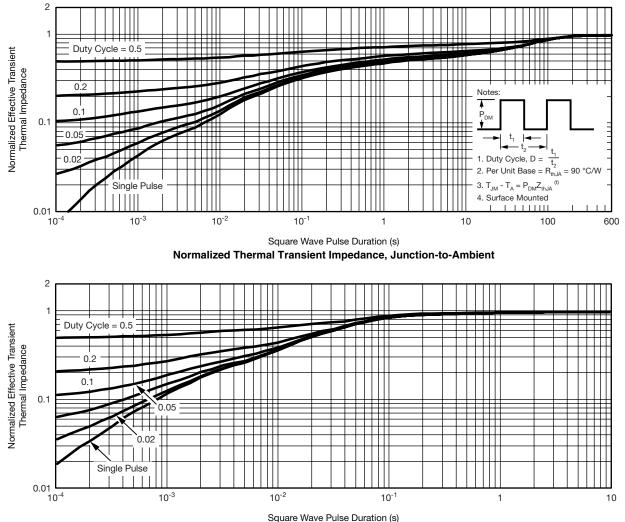


#### N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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#### P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg773629">www.vishay.com/ppg773629</a>.



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